



Specifications

Voltage Rating: 250V(AC,DC)
 Current Rating: 4A(AC,DC)
 Insulation Resistance: 1000MΩ Min.
 Dielectric Withstanding: 1000VAC/minute
 Contact Resistance: 20mΩ Max.
 Operating Temperature: -25°C to +85°C

Wafer

Contact Material: Brass
 Ni 30u" MIN Whole SN:70u" MIN (亮錫)
 Base Material: High Temperature Thermoplastic
 UL 94V-0 Nylon 66 or the equivalent material
 All materials must meet XI BANG
 requirement for environment protection.

No. of PIN/ROW	Dimension		Information
	L	M	
02	4.98	2.54	
03	7.52	5.08	
04	10.06	7.62	
05	12.60	10.16	
06	15.14	12.70	
07	17.68	15.24	
08	20.22	17.78	
09	22.76	20.32	
10	25.30	22.86	
11	27.80	25.40	
12	30.38	27.94	
13	32.92	30.48	
14	35.46	33.02	
15	38.00	35.56	
16	40.54	38.10	
17	43.08	40.64	
18	45.62	43.18	
19	48.16	45.72	
20	50.70	48.26	

Ordering Information

Recommended P.C.Board
 Hole Layout



XB-X254-PCB-103-A002 - XX XX A 002 E 5 B X

ON. of Pins per row
02~20

Standard Plating
01=Tin

Selective plating
02=Gold Flash

Color
5=米黃色

Standard
N=PE Bag
Selective
B=Tray

XB 东莞市溪榜电子有限公司
 DONG GUAN XI BANG ELECTRONICS CO., LTD

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GENERAL TOLERANCE	
X.* ± 1.5*	X. ± 0.30
.X* ± 1.0*	.X ± 0.20
.XX* ± 0.5*	.XX ± 0.15
.XXX* ± 0.3*	.XXX ± 0.10

DESIGN:
 CHECKED:
 AUDITED:

DATE:
 DATE:
 DATE:

DWG. NO.
 XB-X254-PCB-103-A002
 PART NO.

TITLE.
 PITCH 2.54 WAFER